

X=2300  $\mu$ m Y=1600  $\mu$ m

Product Features

- ◆ RF Frequency: 93 to 95 GHz
- ◆ Linear Gain: 10 dB typ.
- ◆ Psat: 23 dBm typ.
- ◆ Die Size: 3.7 sq. mm.
- ◆ 2 mil substrate
- ◆ DC Power: 4 VDC @ 240 mA

Performance Characteristics (Ta = 25°C)

Specification	Min	Typ	Max	Unit
Frequency	93		95	GHz
Linear Gain		10		dB
Input Return Loss	6			dB
Output Return Loss	6			dB
Psat		23		dBm
Vd1, Vd2		4		V
Vg1		-0.2		V
Vg2		-0.1		V
Id1		80		mA
Id2		160		mA

Applications

- ◆ Short Haul / High Capacity Links
- ◆ Sensors

Product Description

The APH484 monolithic HEMT amplifier is a broadband, two-stage power device, designed for use in commercial digital radios and wireless LANs. To ensure rugged and reliable operation, HEMT devices are fully passivated. Both bond pad and backside metallization are Ti/Au, which is compatible with conventional die attach, thermocompression, and thermosonic wire bonding assembly techniques.

Absolute Maximum Ratings (Ta = 25°C)

Parameter	Min	Max	Unit
Vd1, Vd2		4.5	V
Id1		100	mA
Id2		200	mA
Vg1, Vg2	-0.8	0.3	V
Input drive level		15	dBm
Assy. Temperature (60 seconds)		300	deg. C

Note: The data contained in this document is for information only. Northrop Grumman reserves the right to change without notice the specifications, designs, prices or conditions of sale, as they apply to this product. The product represented by this datasheet is subject to U.S. Export Law as contained in the ITAR. **This product is for U.S. Sales only. Export out of the U.S. requires a U.S. State Department export license.**

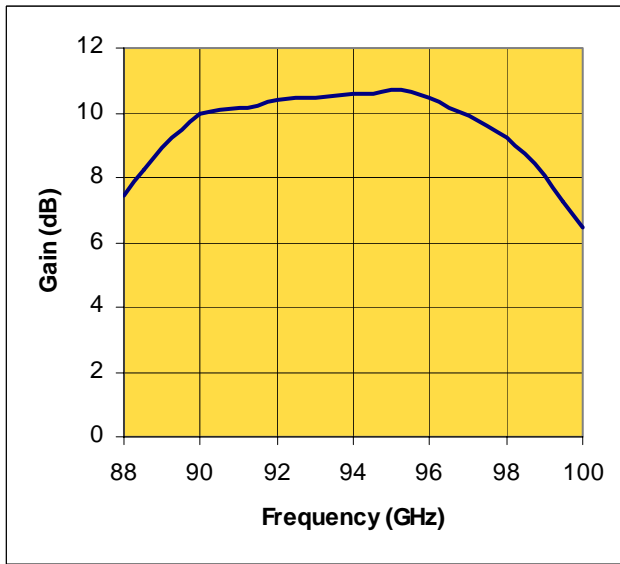


Product Datasheet

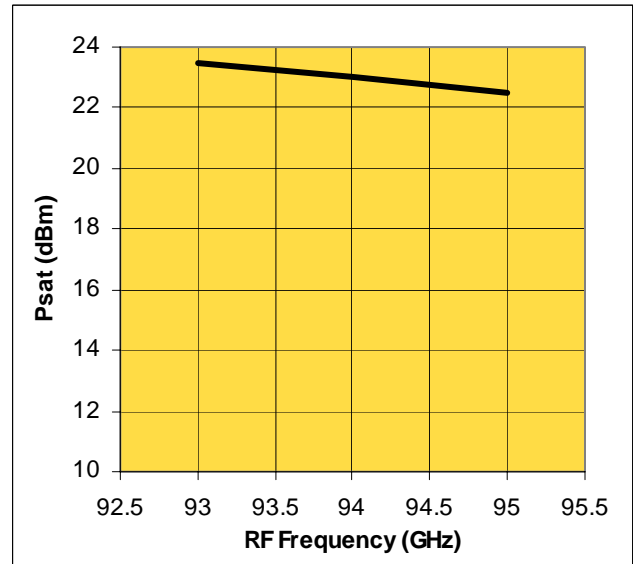
Revision: March 2007

Measured Performance Characteristics (Typical Performance at 25°C)  
 $V_{d1} = V_{d2} = 4V$ ,  $I_{d1} = 80\text{ mA}$ ,  $I_{d2} = 160\text{ mA}$

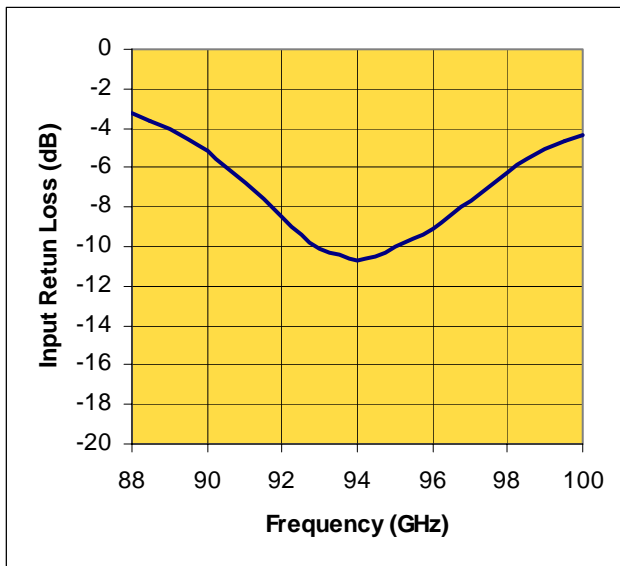
Linear Gain Versus Frequency



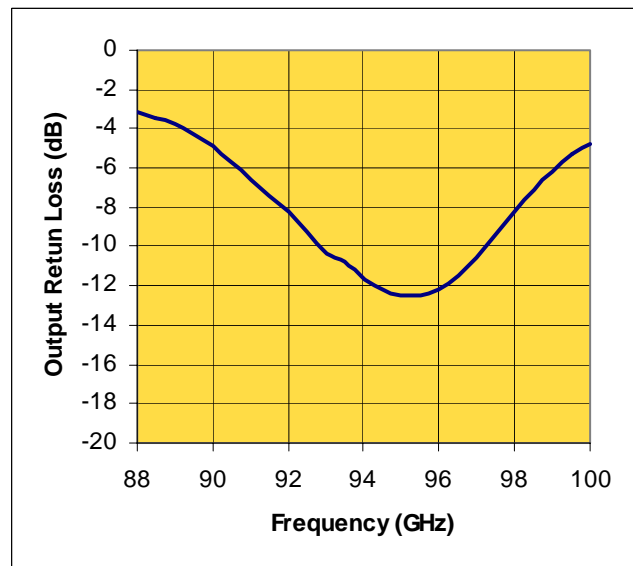
Psat Versus Frequency



Input Return Loss Versus Frequency



Output Return Loss Versus Frequency



Note: The data contained in this document is for information only. Northrop Grumman reserves the right to change without notice the specifications, designs, prices or conditions of sale, as they apply to this product. The product represented by this datasheet is subject to U.S. Export Law as contained in the ITAR. **This product is for U.S. Sales only. Export out of the U.S. requires a U.S. State Department export license.**



## Product Datasheet

Revision: March 2007

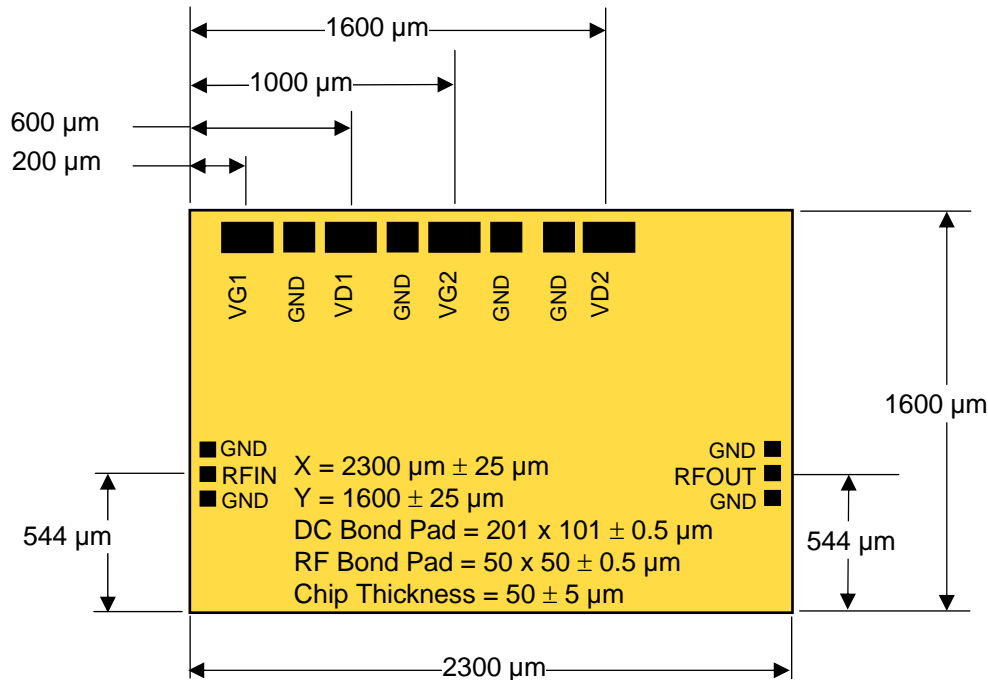
Measured Performance Characteristics (Typical Performance at 25°C)  
 $V_{d1} = V_{d2} = 4V$ ,  $I_{d1} = 80\text{ mA}$ ,  $I_{d2} = 160\text{ mA}$

Freq GHz	S11 Mag	S11 Ang	S21 Mag	S21 Ang	S12 Mag	S12 Ang	S22 Mag	S22 Ang
88.0	0.69	-144.62	2.36	-28.66	0.02	-24.89	0.69	-166.70
88.5	0.66	-151.60	2.58	-38.67	0.02	-31.18	0.68	-173.47
89.0	0.63	-159.44	2.78	-50.38	0.03	-42.59	0.65	178.89
89.5	0.60	-168.04	2.97	-62.95	0.03	-53.41	0.61	171.18
90.0	0.55	-176.83	3.14	-76.05	0.03	-65.70	0.57	163.02
90.5	0.50	174.75	3.20	-89.36	0.03	-77.06	0.52	155.43
91.0	0.46	166.13	3.23	-101.26	0.03	-87.92	0.47	148.37
91.5	0.42	156.77	3.25	-113.07	0.03	-102.29	0.43	141.08
92.0	0.38	146.37	3.32	-124.41	0.03	-112.84	0.39	132.53
92.5	0.34	137.01	3.34	-136.37	0.03	-125.44	0.34	124.54
93.0	0.31	127.26	3.35	-148.18	0.03	-137.77	0.31	117.17
93.5	0.30	116.93	3.36	-159.17	0.03	-142.08	0.29	108.13
94.0	0.29	106.36	3.38	-170.86	0.03	-152.36	0.26	98.14
94.5	0.30	95.56	3.39	177.58	0.03	-162.32	0.25	88.27
95.0	0.32	82.82	3.42	165.21	0.03	-173.74	0.24	77.20
95.5	0.33	70.32	3.40	152.12	0.04	175.98	0.24	65.63
96.0	0.35	59.64	3.33	139.35	0.04	157.98	0.25	55.46
96.5	0.38	48.81	3.21	127.11	0.04	145.04	0.27	44.73
97.0	0.41	39.44	3.13	114.55	0.04	126.30	0.30	36.06
97.5	0.45	30.57	3.02	101.89	0.03	112.41	0.34	25.64
98.0	0.49	22.36	2.90	88.86	0.03	98.80	0.39	15.81
98.5	0.53	13.88	2.73	75.47	0.03	77.59	0.44	5.95
99.0	0.56	5.62	2.53	62.39	0.02	69.96	0.49	-3.76
99.5	0.58	-1.49	2.31	49.71	0.02	52.00	0.54	-13.92
100.0	0.61	-8.45	2.11	37.96	0.01	47.68	0.58	-22.85

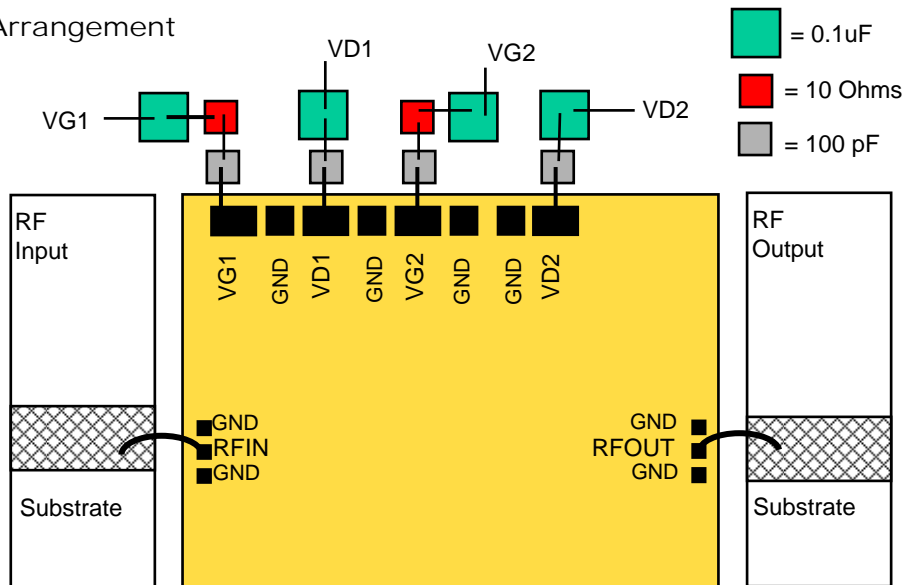
Note: The data contained in this document is for information only. Northrop Grumman reserves the right to change without notice the specifications, designs, prices or conditions of sale, as they apply to this product. The product represented by this datasheet is subject to U.S. Export Law as contained in the ITAR. **This product is for U.S. Sales only. Export out of the U.S. requires a U.S. State Department export license.**



Die Size and Bond Pad Locations



Suggested Bonding Arrangement



Recommended Assembly Notes

1. Bypass caps should be 100 pF ceramic (single-layer) placed no further than 30 mils from the amplifier.
2. Best performance obtained from use of <6 mil (long) by 1.5 by 0.5 mil ribbons on input and output.

Note: The data contained in this document is for information only. Northrop Grumman reserves the right to change without notice the specifications, designs, prices or conditions of sale, as they apply to this product. The product represented by this datasheet is subject to U.S. Export Law as contained in the ITAR. **This product is for U.S. Sales only. Export out of the U.S. requires a U.S. State Department export license.**